



## **PCT**

### INTERNATIONAL PRELIMINARY EXAMINATION REPORT

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HILLANIA	(PCT Article 36 a		• .
Applicant's or agent's file reference	FOR FURTHER ACTIO	. See Notific	ation of Transmittal of International
2002P14485WO International application No. PCT/DE2003/002930	International filing date (date of the content of t	y/month/year)	Priority date (day/month/year) 05 September 2002 (05.09.2002)
International Patent Classification (IPC) or a H01L 51/20	1		
Applicant	SIEMENS AKTIENGE	ELLSCHAF	r
amended and are the basis to 70.16 and Section 607 of the	for this report and/or sheets cone Administrative Instructions total ofshee	under the PCT).	on, claims and/or drawings which have be ations made before this Authority (see Ru
IV Lack of unity of i  V Reasoned statement citations and exp  VI Certain document  VII Certain defects in	t  nt of opinion with regard to no invention ent under Article 35(2) with re lanations supporting such stat	egard to novelty, ement	step and industrial applicability inventive step or industrial applicability;
Date of submission of the demand		Pate of completion	n of this report
05 April 2004 (05.0			December 2004 (01.12.2004)
Name and mailing address of the IPEA/	EP	Authorized office	r
Passimile No		Telephone No.	



International application No.

#### PCT/DE2003/002930

#### INTERNATIONAL PRELIMINARY EXAMINATION REPORT

I. Basis of the report							
1. With regard to the elements of the international application:*							
		the inter	national application as originally filed	•			
	$\overline{\boxtimes}$	the descr	iption:	1			
•		pages _	1-6	, as originally filed			
		pages _		, filed with the demand			
		pages _	, filed with the letter of				
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		pages	1-6	, as originally filed			
		pages	, as amended (together with any s	statement under Article 19			
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		which is:  )).  tion (under Rule 55.2 and/ plication, the international					
		intern The s	statement that the subsequently furnished written sequence listing does not go bey ational application as filed has been furnished.  Itatement that the information recorded in computer readable form is identical to the voluments.				
	4	This r	the description, pages the claims, Nos the drawings, sheets/fig eport has been established as if (some of) the amendments had not been made, since they d the disclosure as filed, as indicated in the Supplemental Box (Rule 70.2(c)).**	have been considered to go			
	in i	olacemen this repo l 70.17).	t sheets which have been furnished to the receiving Office in response to an invitation und ort as "originally filed" and are not annexed to this report since they do not contai ment sheet containing such amendments must be referred to under item 1 and annexed to th	n amendments (Rule 70.10			
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#### INTERNATIONAL PRELIMINARY EXAMINATION REPORT

Internation plication No.

PCT/DE 03/02930

<b>.</b> 7	Reasoned statement under Article 35(2) with regard to novelty, inventive step or industrial applicability
••	situtions and explanations supporting such statement

1. Statement	•		
Novelty (N)	Ciaims	2	YES
	Claims	1, 3-6	NO
Inventive step (IS)	Claims		YES
inventive step (13)	Claims	2	NO
Industrial applicability (IA)	Claims	1-6	YES
	Claims		NO

2. Citations and explanations

Reference is made to the following documents:

D1: EP-A-1 213 775 and

D2: WO 99/30375.

D1 discloses an organic photovoltaic component containing a substrate, a positive electrode, an organic semiconductor and a negative electrode (see figures 1 and 2), a transport layer (layer 4) being structured between the electrode (3) and the semiconductor layer (5) (see figure 2). The claimed component is also known from D2, all the layers, including the substrate, being structured (see figure 2 and page 7, lines 11 to 19). Thus the components known from D1 and D2 display all the features of claims 1 and 3 of the application. Consequently the subject matter of these claims is not novel (PCT Article 33(2)).

The structuring as per D1 or D2 of the semiconductor layer (5 in D1, 202 in D2) of the component is also achieved by retaining existing structuring of a lower layer (4 in D1, 204 in D2), to which the semiconductor layer is applied. This lower layer has to be considered an additional layer. Furthermore, as figure 2 of D1 clearly shows, the



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semiconductor layer planarizes the structuring of the lower layer. Claims 4 to 6 do not meet the requirements of PCT Article 33(1) since their subject matter is not novel (PCT Article 33(2)).

The substrate selected in D1 can be a flexible film (paragraphs 0068 and 0071); according to D2, the substrate can be structured (page 7, lines 17 to 19). A person skilled in the art would consider it conventional procedure to combine these features. Therefore the subject matter of claim 2 does not involve an inventive step and hence does not meet the requirements of PCT Article 33(1) and (3).